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To the Honorable Commissioner of Patents and Trademarks. Please record the attached original documents or copy thereof

1. Name of conveying party(ies):
Naoki Hosoya, Yuuji Takagi, Hisae Shibuya, Kenji Obara

Additional name(s) of conveying parties attached? Yes No

2. Name and address of receiving party(ies)
Name: HITACHI, LTD.

Internal Address: _____

Street Address: 6, Kanda Surugadai 4-chome

City: Chiyoda-ku, Tokyo, Japan

10/015276
12/11/01
JCS U.S. PTO

3. Nature of conveyance:
 Assignment Merger
 Security Agreement Change of Name
 Other: _____

Additional names and addresses attached? Yes No

Execution Date: December 3, 2001

4. Application number(s) or patent number(s).
If this document is being filed together with a new application, the execution date of the application is: December 3, 2001

A. Patent Application No(s): _____

B. Patent No(s): 10/015276

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:
Name: George B. F. Yee
TOWNSEND AND TOWNSEND AND CREW LLP
Two Embarcadero Center, 8th Floor
San Francisco, California 94111-3834
(650) 326-2400

6. Total number of applications and patents involved 1

7. Total fee (37 CFR 3.41): -----\$40.00

Enclosed
 Authorized to be charged to deposit account

8. Deposit account number: 20-1430

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9. Statement and signature.
To the best of my knowledge and belief, the foregoing is true and correct and any attached copy is a true of copy of the original document.

George B. F. Yee
Name of Person Signing
Atty. Reg. No. 37,478

George B. F. Yee
Signature

December 11, 2001
Date

Total number of pages including cover sheet, attachments and document 2

Mail documents to be recorded with required cover to:
Commissioner of Patents and Trademarks, Box Assignments
Washington, D.C. 20231

ASSIGNMENT

(譲 渡 証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI, LTD., a corporation organized under the laws of Japan, located at 6, Kanda Surugadai 4-chome, Chiyoda-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI, LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

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invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI, LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI, LTD.

Signed on the date(s) indicated aside signatures:

INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1) <u>Naoki Hosoya</u>	<u>Dec. 3, 2001</u>
2) <u>Yuji Takagi</u>	<u>Dec. 3, 2001</u>
3) <u>Kisao Inibuya</u>	<u>Dec. 3, 2001</u>
4) <u>Kenji Ohara</u>	<u>Dec. 3, 2001</u>
5) _____	_____
6) _____	_____
7) _____	_____
8) _____	_____
9) _____	_____
10) _____	_____